

Publications

Parts of this work are published in:

- 1) **I. V. Hertel, R. Stoian, D. Ashkenasi, A. Rosenfeld, E.E.B. Campbell**
“Surface and bulk ultrashort pulsed laser processing of transparent materials”
LPM2000, SPIE Proceedings, (2000)
- 2) **R. Stoian, D. Ashkenasi, A. Rosenfeld, R. Kelly, E.E.B. Campbell,**
“Coulomb Explosion in Ultrashort Pulsed Laser Ablation of Al_2O_3 ”
Phys. Rev. B. 62, 13167-13173, (2000)
- 3) **R. Stoian, D. Ashkenasi, A. Rosenfeld, M. Witmann, R. Kelly, E.E.B. Campbell,**
“The dynamics of Ion Expulsion in Ultrashort Pulse Laser Sputtering of Al_2O_3 ”
Nucl. Instr. Meth. Phys. Res. B 166-167, 682-690, (2000)
- 4) **R. Stoian, H. Varel, A. Rosenfeld, D. Ashkenasi, R. Kelly, E.E.B. Campbell**
“Ion time-of-flight analyses of ultrashort pulsed laser-induced processing of Al_2O_3 ”
Appl. Surf. Sci. 165, 44-55, (2000)
- 5) **R. Stoian, D. Ashkenasi, A. Rosenfeld, E.E.B. Campbell**
“Laser ablation of sapphire with ultrashort pulses”
Advanced High Power Laser Application (AHPLA) SPIE Proceedings, C. R. Phipps
and M. Niino eds. 3885, 121-31, (2000)
- 6) **R. Stoian, D. Ashkenasi, A. Rosenfeld, M. Lorenz, E.E.B. Campbell**
“Dynamics of material removal in ultrashort laser ablation of dielectrics”
CLEO 2000 Technical Digest, 615, CFK4, (2000)
- 7) **M. Lorenz, A. Rosenfeld, R. Stoian, D. Ashkenasi**
“Beam propagation of intense ultrashort pulses inside transparent dielectric materials
for controlled 3D micro structuring
CLEO 2000 Technical Digest, 612, CFK1, (2000)
- 8) **D. Ashkenasi, R. Stoian, A. Rosenfeld**
“Single and multiple ultra-short laser pulse ablation threshold of Al_2O_3 (corundum) at
different etch phases.
Appl. Surf. Sci. 154-155, 40-46, (2000)
- 9) **D. Ashkenasi, M. Lorenz, R. Stoian, A. Rosenfeld**
“Surface damage threshold and structuring of dielectrics using femtosecond laser
pulses: the role of incubation”
Appl. Surf. Sci. 150, 101-106, (1999)
- 10) **R. Stoian, M. Lorenz, D. Ashkenasi, A. Rosenfeld, E.E.B. Campbell**
“Non-thermal and thermal processes in the ultra-short laser ablation of sapphire”
CLEO 1999 Technical Digest, 356, CFC1, (1999)

Publications

11) M. Lorenz, R. Stoian, D. Ashkenasi, A. Rosenfeld, E.E.B. Campbell

“Surface damage threshold and structuring of brittle dielectrics with ultra-short laser pulses”

CLEO 2000 Technical Digest, 382, CFH2, (2000)

12) A. Rosenfeld, D. Ashkenasi, E. E. B. Campbell, M. Lorenz, R. Stoian and H. Varel

“Material processing with femtosecond laser pulses”

Lasers'98, 7-23, V. J. Corcoran and T. A. Goldman eds. (STS Press Mc Lean, VA, Tucson, AR, USA, (1999)

13) A. Rosenfeld, M. Lorenz, D. Ashkenasi, R. Stoian,

“Ultrashort-laser pulse damage threshold of transparent materials and the role of incubation”

Appl. Phys. A 69(Suppl.), S373-S376, (1999)

14) D. Ashkenasi, G. Herbst, A. Rosenfeld, H. Varel, M. Lorenz, R. Stoian, E.E.B. Campbell,

“Laser ablation and structuring of transparent materials with ultrashort laser pulses”

SPIE 3343, 400, (1998)